

**DECLARATION AND POWER OF ATTORNEY  
FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**A MATERIAL FOR MAKING HYPER FREQUENCY MULTI-LAYER CHIP INDUCTORS  
WITH HIGH PERFORMANCE AND LOW SINTERING TEMPERATURE AND A PROCESS  
FOR PREPARING THE MATERIAL**

the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I also acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37 CFR 1.63(d), which occurred between the filing date of the prior application and the filing date of the continuation-in-part application, if this is a continuation-in-part application.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

<b>Prior Foreign Application:</b>	<b>Country:</b>	<b>China</b>
	<b>Appln. No.:</b>	<b>00 123598.2</b>
	<b>Filed:</b>	<b>August 25, 2000</b>

I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

10/28/00 9:55:50

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**Full Name of Sole or First Inventor: Xiaohui WANG**

Inventor's signature: \_\_\_\_\_

Dated: \_\_\_\_\_  
Month/Day/Year

Residence:

Citizenship:

Post Office Address:

**Full Name of Second Joint Inventor: Longtu LI**

Inventor's signature: \_\_\_\_\_

Dated: \_\_\_\_\_  
Month/Day/Year

Residence:

Citizenship:

Post Office Address:

**Full Name of Third Joint Inventor: Ji ZHOU**

Inventor's signature: \_\_\_\_\_

Dated: \_\_\_\_\_  
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Residence:

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**Full Name of Fourth Joint Inventor: Zhengxing YUE**

Inventor's signature: \_\_\_\_\_

Dated: \_\_\_\_\_  
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Residence:

Citizenship:

Post Office Address:

**Full Name of Fifth Joint Inventor: Zhenwei MA**

Inventor's signature: \_\_\_\_\_

Dated: \_\_\_\_\_  
Month/Day/Year

Residence:

Citizenship:

Post Office Address:

**Full Name of Sixth Joint Inventor: Shuiyuan SU**

Inventor's signature: \_\_\_\_\_

Dated: \_\_\_\_\_  
Month/Day/Year

Residence:

Citizenship:

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